ANG CAO

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RESEARCH INTERESTS

I am broadly interested in 3D vision. My current work is mainly about learning 3D models from 2D images using differentiable rendering and novel view synthesis for dynamic/static scenes.

EDUCATION

University of Michigan, Ann Arbor	$\it 2020$ -present
Ph.D., Computer Science and Engineering	$GPA \ 4.0/4.0$
Advisor: Prof. Justin Johnson	
University of Michigan, Ann Arbor	2018-2020
Master of Science, Electrical and Computer Engineering	$GPA \ 4.0/4.0$
Signal & Image Processing and Machine Learning track (SIPML)	
Wuhan University	2014-2018
Bachelor of Science in Electrical Engineering	GPA 3.9/4.0

PUBLICATIONS

5. "Text2room:Text2Room: Extracting Textured 3D Meshes from 2D Text-to-Image Models"

Lukas Höllein*, **Ang Cao***, Andrew Owens, Justin Johnson, Matthias Nießner *In submission*, 2023

4. "HexPlane: A Fast Representation for Dynamic Scenes"

Ang Cao, Justin Johnson

Computer Vision and Pattern Recognition Conference, CVPR 2023

3. "FWD: Real-time Novel View Synthesis with Forward Warping and Depth"

Ang Cao, Chris Rockwell, Justin Johnson

Computer Vision and Pattern Recognition Conference, CVPR 2022

2. "Inverting and Understanding Object Detector"

Ang Cao, Justin Johnson

Tech Report 2021

1. "Unified Signal Compression Using Generative Adversarial Networks"

Bowen Liu*, Ang Cao*, Hun-Seok Kim

45th International Conference on Acoustics, Speech, and Signal Processing, ICASSP 2020, oral.

AWARDS AND RECOGNITIONS

Rollin M. Gerstacker Foundation Fellowships, University of Michigan	2020
China National Scholarship, award for top 2% Chinese undergraduate	2016, 2017
Outstanding Graduate of Wuhan University	2018
Meritorious Winner of American Mathematical Contest in Modeling	2017
National Undergraduate Innovation Foundation by Chinese Ministry of Education	2016

ACTIVITIES

AI4ALL, University of Michigan

2021

Summer program aimed at providing an entry point to artificial intelligence, computer science and engineering to high school students from under-represented backgrounds.

REVIEWER

CVPR 2023, ICLR 2023, CVPR 2022, ICCV 2022.